

RACON 12 S, SMT, 2.5 ± 0.6 N, 1 NO



fields of application

- > Measurement-control-regulation
- > Mechanical and system engineering
- > Automotive
- > Electro-medical

special features

- > Gold contacts, reliable switching with low currents
- > Special tactile feedback
- > Different operating forces
- > Variable overall heights due to plunger
- > Terminal technology: SMT or THT
- > Traceability through product identification
- > sealable (tested media see Downloads)

ϵ

description

Our top-quality RACON 12 tactile switches – in the dimensions 12 x 12 mm – feature an unmistakeable click, high switching reliability, a sealed contact system and castability. That has made RACON the standard in many industries. Whether for automotive applications, systems with keycaps, or membrane keyboards, RACON impresses in the THT or SMT versions – for your application too.

RACON 12 tactile switches can be arranged individually, in rows or as key blocks. When used beneath membrane overlays, the RACON key switches should be combined with plungers. Suitable for the most important soldering techniques.

Soldering bath for THT versions

Reflow soldering for SMT versions

Vapor phase soldering for SMT versions

Manual soldering

Processing of the SMT designs with SMT automatic assembly machines

IMDS entry

technical data

>	genera	١

Color blue
Operating temperature, min. -40 °C

Operating temperature, max. 90 °C
Storage temperature, min. -50 °C
Storage temperature, max. 90 °C
illuminated No
Soldering Reflow

Solder heat resistance according DIN EN 60068-2-58

to standard

direct links

> RAFI eCatalog



Packaging Blister
Packaging unit 750 pcs.
net weight 1.5 g

Operating life 1,000,000 cycles B10 1,300,000 cycles

Degree of protection, front side, according to DIN EN 60529 IPx7
Degree of protection, rear side, according to DIN EN 60529 IPx7
MSL Moisture Sensitivity Level 1
Corrosive gas testing according to Yes

standard

MOQ order 750 pcs.

RoHS compliant Yes

REACH compliant Yes

Component material Elastomer

Product code 2C

> mounting diameters

Outside dimension, length 12 mm
Outside dimension, width 12 mm

Installation height $4.95 \pm 0.1 \text{ mm}$ Grid, min. $12.50 \times 15.24 \text{ mm}$

> mechanical data

Actuation function momentary contact function

Operating force, max. 8 N

Operating force, min. $2.5 \pm 0.6 \text{ N}$

Switching travel 0.55^{±0.1} mm

Contact function 1 NO

Contact system Snap-action contact

SPST - Single Pole Single Throw

Contact material Gold
Solderability Yes
Terminal on the rear SMT

> electrical data

Rated voltage, min.

Rated voltage, max.

Rated current, min.

Rated current, max.

O.1 A

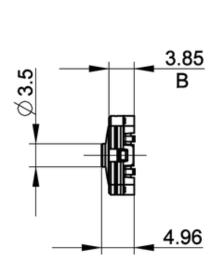
Rated power, max.

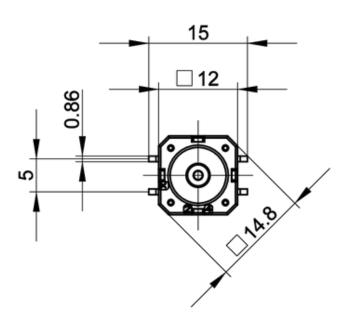
1 W



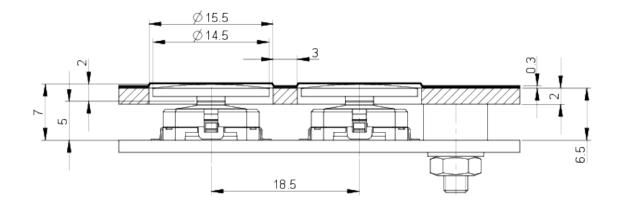
drawings

Dimensioned drawing



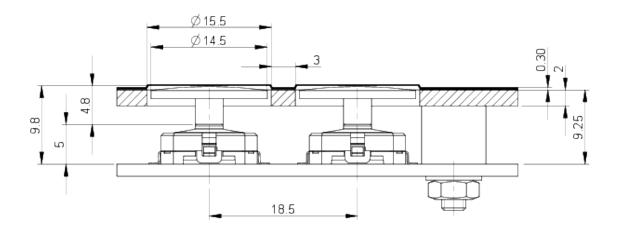


System drawing



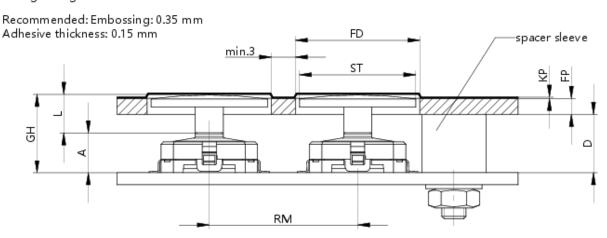


System drawing



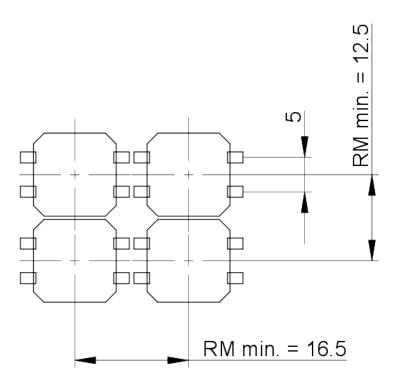
System drawing

SMT gullwing connection

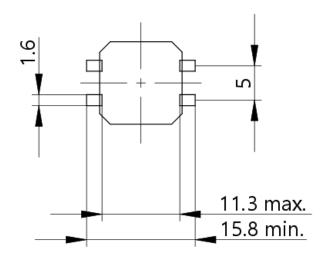




PCB drawing



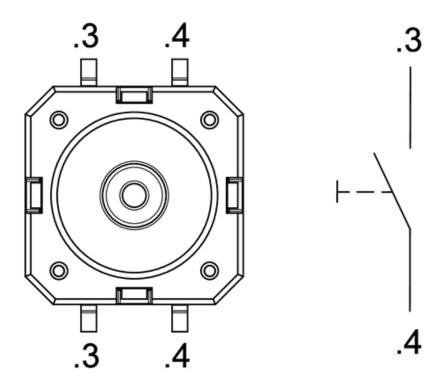
PCB drawing



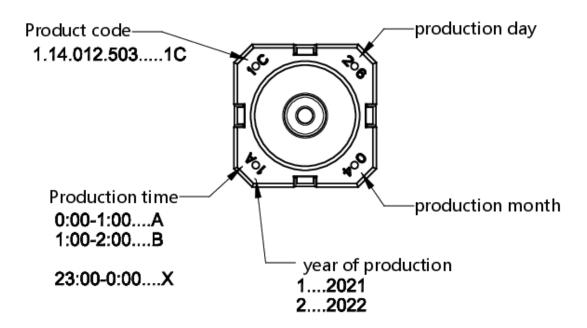
PCB-Pad component side



Schematic diagram

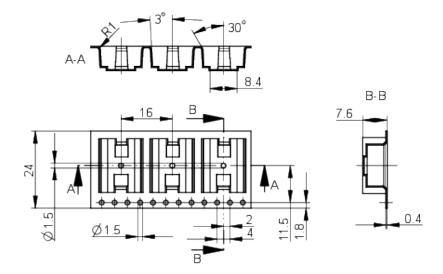


Product labeling drawing





Packaging drawing



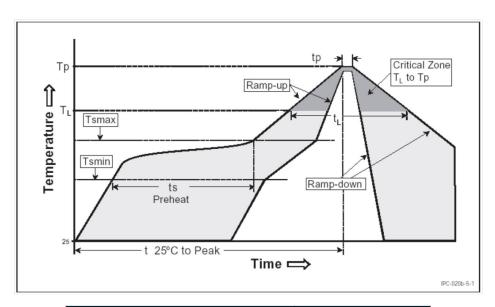


mounting

RAFI soldering profile for ROHS compliant reflow components



Publication date: October 7, 2021



Parameter	RAFI values
Gradient (T _L to T _P)	max. 3°C/s
Preheating zone Minimum temperature (T _{smin}) Maximum temperature (T _{smax}) Time (from min. to max.) (ts)	150°C 200°C 60 - 120 s
Gradient (T _{smax} to T _L)	max. 3°C/s
$\label{eq:total_continuity} \begin{tabular}{ll} Time over \\ melting temperature (T_L) \\ time (t_L) \\ \end{tabular}$	217°C 60 – 150 s
Peak temperature (T _P)	max. 260°C (+0°C)
Time within peak temperature – 5°C (tp)	20-40 s
Gradient ramp down	max. 6°C / s
Time difference from 25°C to peak temperature	max. 8 minutes

The reflow soldering profile is based on the definition of Jedec J-STD-020D.

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Medium Robust Electronics



Publication date: July 25, 2022

RACON 12 S

Valid for all variants RACON 12 S, 1.14.012.5XX-9XX

Approved potting compounds

WEVO-CHEMIE GmbH
 WEVOPUR 7210 FL/WEVONAT 507
 WEVOPUR PD4431 FL/WEVONAT 300

STOCKMAIER URETHANES GmbH & Co.KG
 Stobicast® L768.16 Polyol/Isocyanat

Important note

Maximum potting height B must not be exceeded.

Approved circuit board protection

Important note

If the tactile switch is completely painted, the paint may peel off the elastomer of the tactile switch during the first few actuations. Press the tactile switch only after the paint has hardened. We recommend leaving out the elastomer area when painting to prevent detachment.

TIEFCO Coating Company
 3M[™] Novec[™] 1700

Important note

After coating, the contact resistance can increase. After repeated actuation, the contact resistance drops again under 100 m Ω .

General remark:

The potting, varnish and nano medium must be used in accordance with the manufacturer's technical data sheet. Actuation of the tactile switch only after the potting compound, varnish and nano medium has hardened.

Other potting compounds and processes for printed circuit board protection on request.

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date: Feb 28, 2024 page: 9/9

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